

Bipolar Transistors Silicon NPN Triple-Diffused Type

# **TTC008**

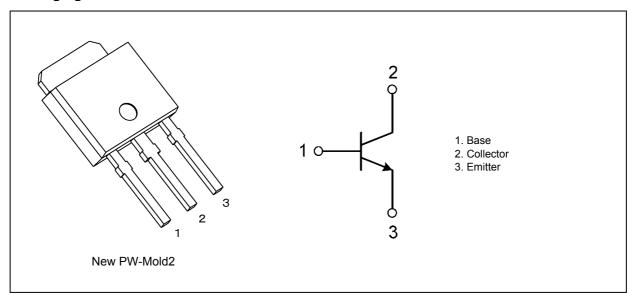
# 1. Applications

- · High-Speed High-Voltage Switching
- · Switching Voltage Regulators
- · High-Speed DC-DC Converters

#### 2. Features

- (1) High collector-emitter voltage:  $V_{CEO} = 285 \text{ V}$ ,  $V_{CES} = 600 \text{ V}$
- (2) High DC current gain:  $h_{\rm FE}$  = 100 to 200 ( $I_{\rm C}$  = 0.3 A)
- (3) Excellent switching times: $t_f = 0.1 \mu s$  (typ.)

## 3. Packaging and Internal Circuit



### 4. Absolute Maximum Ratings (Note)

Unless otherwise specified, Ta = 25°C

| Characteristics             |          |                  | Rating     | Unit |
|-----------------------------|----------|------------------|------------|------|
| Collector-base voltage      |          | V <sub>CBO</sub> | 600        | V    |
| Collector-emitter voltage   |          | V <sub>CES</sub> | 600        |      |
| Collector-emitter voltage   |          | V <sub>CEO</sub> | 285        |      |
| Emitter-base voltage        |          | V <sub>EBO</sub> | 7          |      |
| Collector current (DC)      | (Note 1) | Ic               | 1.5        | Α    |
| Collector current (pulsed)  | (Note 1) | I <sub>CP</sub>  | 3          |      |
| Base current                |          | I <sub>B</sub>   | 0.75       |      |
| Collector power dissipation |          | P <sub>C</sub>   | 1.1        | W    |
| Junction temperature        |          | Tj               | 150        | °C   |
| Storage temperature         |          | T <sub>stg</sub> | -55 to 150 |      |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



#### 5. Electrical Characteristics

Unless otherwise specified, Ta = 25°C

#### 5.1. Static Characteristics

| Characteristics                      | Symbol               | Test Condition                                   | Min | Тур. | Max | Unit |
|--------------------------------------|----------------------|--|-----|------|-----|------|
| Collector cut-off current            | I <sub>CBO</sub>     | V <sub>CB</sub> = 600 V, I <sub>E</sub> = 0 A    | _   | _    | 10  | μА   |
| Emitter cut-off current              | I <sub>EBO</sub>     | V <sub>EB</sub> = 7 V, I <sub>C</sub> = 0 A      |     | _    | 100 | nA   |
| Collector-base breakdown voltage     | V <sub>(BR)CBO</sub> | I <sub>C</sub> = 1 mA, I <sub>E</sub> = 0 A      | 600 | _    | _   | V    |
| Collector-emitter breakdown voltage  | V <sub>(BR)CEO</sub> | I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0 A     | 285 | _    | _   |      |
| DC current gain                      | h <sub>FE(1)</sub>   | V <sub>CE</sub> = 5 V, I <sub>C</sub> = 1 mA     | 80  | _    | 250 | _    |
|                                      | h <sub>FE(2)</sub>   | $V_{CE} = 5 \text{ V}, I_{C} = 0.3 \text{ A}$    | 100 | _    | 200 |      |
| Collector-emitter saturation voltage | V <sub>CE(sat)</sub> | I <sub>C</sub> = 0.5 A, I <sub>B</sub> = 62.5 mA | _   | _    | 1.0 | V    |
| Base-emitter saturation voltage      | V <sub>BE(sat)</sub> | I <sub>C</sub> = 0.5 A, I <sub>B</sub> = 62.5 mA | _   | _    | 1.3 |      |

# 5.2. Dynamic Characteristics

| Characteristics               | Symbol           | Test Condition    | Min | Тур. | Max | Unit |
|-------------------------------|------------------|-------------------|-----|------|-----|------|
| Switching time (rise time)    | t <sub>r</sub>   | See Figure 5.2.1. | _   | 0.05 |     | μS   |
| Switching time (storage time) | t <sub>stg</sub> |                   |     | 3.3  |     |      |
| Switching time (fall time)    | t <sub>f</sub>   |                   | _   | 0.1  |     |      |

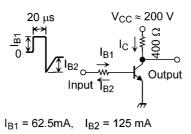


Fig. 5.2.1 Switching Time Test Circuit

Duty cycle ≤ 1%

# 6. Marking (Note)

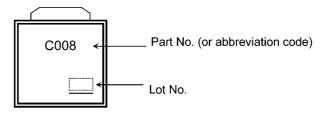


Fig. 6.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

# 7. Characteristics Curves (Note)

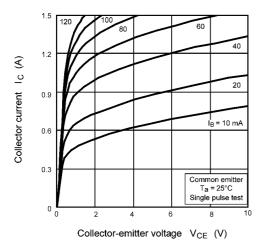


Fig. 7.1 I<sub>C</sub> - V<sub>CE</sub>

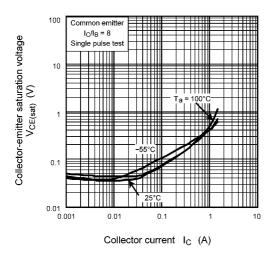


Fig. 7.3 V<sub>CE(sat)</sub> - I<sub>C</sub>

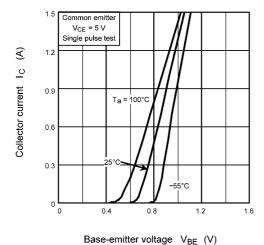


Fig. 7.5 I<sub>C</sub> - V<sub>BE</sub>

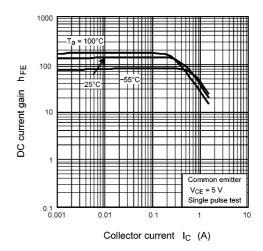


Fig. 7.2 hFE - IC

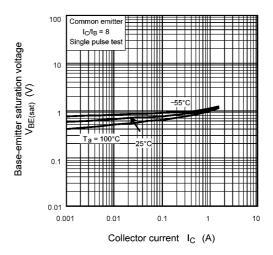


Fig. 7.4  $V_{BE(sat)}$  -  $I_C$ 

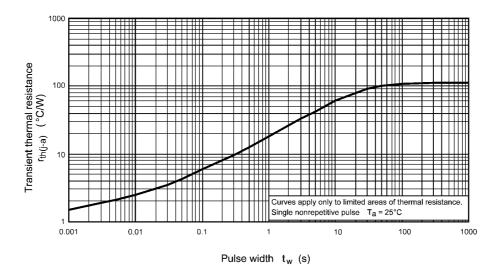


Fig. 7.6 r<sub>th(j-a)</sub> - t<sub>w</sub> (Guaranteed Maximum)

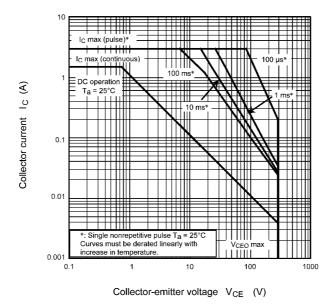


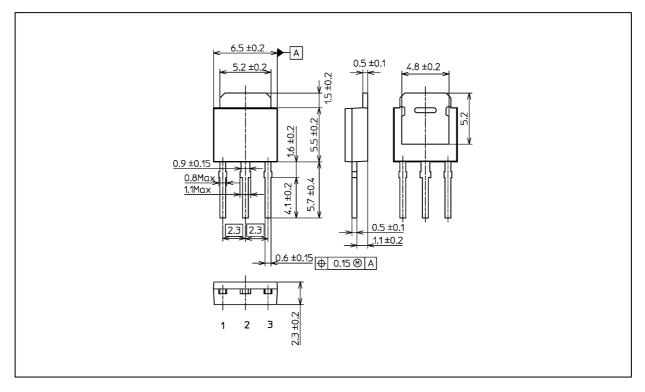
Fig. 7.7 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# **Package Dimensions**

Unit: mm



Weight: 0.36 g (typ.)

| Package Name(s)        |
|------------------------|
| TOSHIBA: 2-7J2S        |
| Nickname: New PW-Mold2 |

Rev.1.0



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